



New Horizons P/L Technology Adaptation

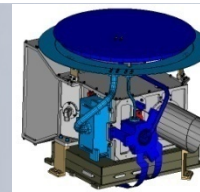


- **There was little new technology developed for the NH science payload.**
 - Difficult to get selected proposing a payload with technology development requirements.
 - Most instrument new technology development is done on grants or internal research funding well in advance of an AO.
- **However, there was a good bit of technology adaptation.**
 - Need to the use of “newer” technologies was driven mainly by the need to keep mass and power requirements to a minimum.
 - Consideration was given at every step to the schedule impact of any use of less than mature technology.
- **Charts following show some specific examples of the adaptation of newer technologies to save mass and/or power.**

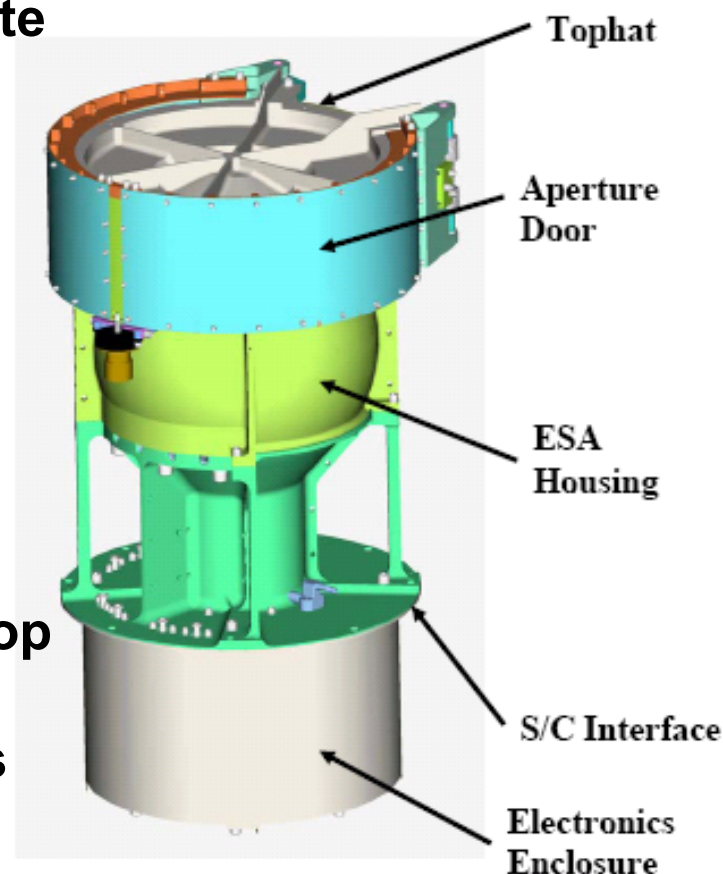




SWAP Technology Issues

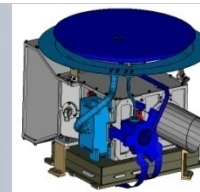


- For SWAP it was necessary to develop a new manufacturing technology to fabricate the RPA grid at the entrance to the analyzer.
- Tried to make a four layer RPA grid that was free-standing so that there was no obstruction in our 270 deg FOV.
- Tried several methods and vendors (electroforming, laser cut, etc.)
- In the end, nothing could survive our vibration environment until we a local shop figure out how to drill hundreds of thousands of close-packed 13.5 mil holes on 15 mil centers leaving 1.5 mil web.

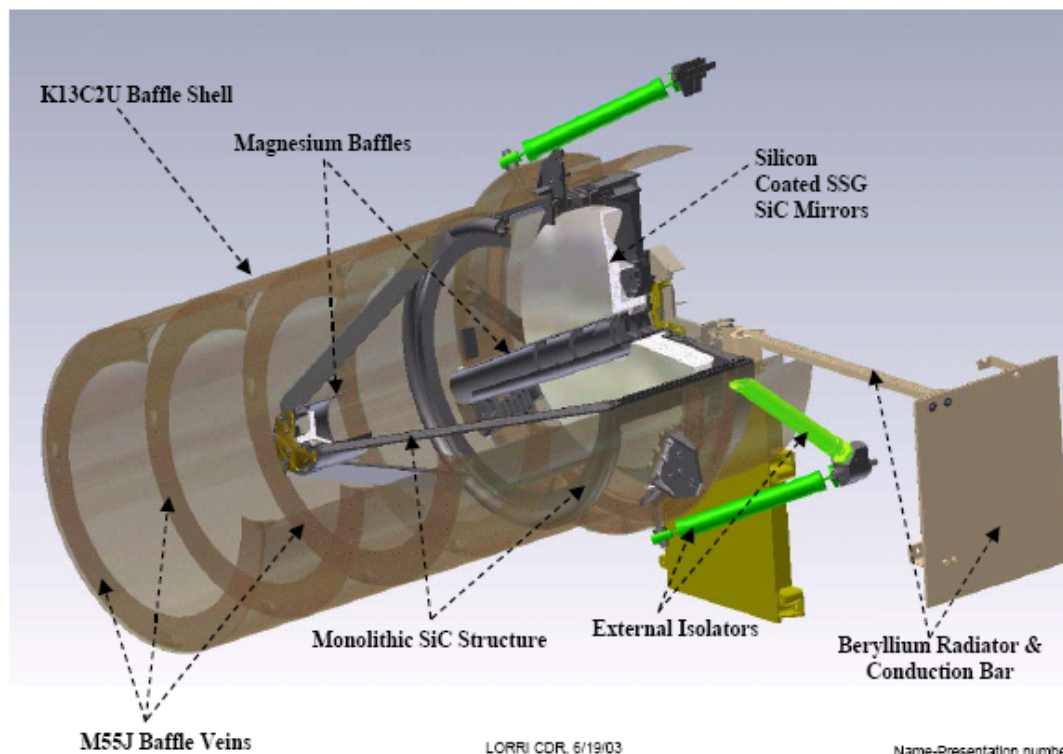




LORRI Technology Adaptation



- For LORRI the technology adaptation was the SiC optics.
- The original design of LORRI did not use SiC optics and was seriously overweight.
- The CCD detector was a conventional device from E2V.
 - Cooling was a challenge.
 - A BeCu bar from the back side of the detector to a dedicated radiator was used for thermal control.





Ralph Technology Adaptation Issues

Thermal Straps/FP Interface

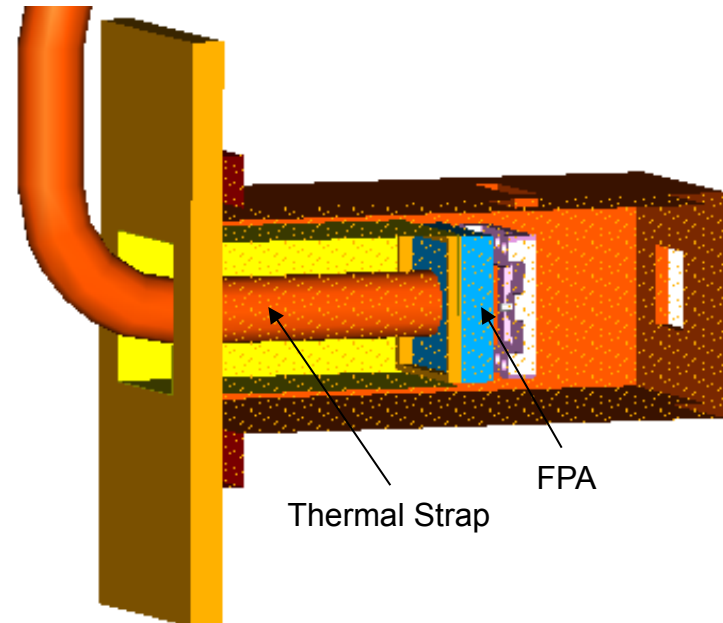


- **Design challenges of thermal straps**
 - Available length
 - Heat load to move
 - Interface design
 - Relative location of cryogenic radiator to FP assemblies (LEISA and MVIC)
- **K1100 strap made from K1100 fibers**
 - Selected for large thermal conductance and small mass
- **Three straps required**
 - 95 K LEISA FP to radiator
 - 150 K MVIC FP to radiator
 - 150 K LEISA shield to radiator
- **Strap will mount to their respective mounting surface with indium**
- **Will utilize strap design conducted on past programs**
- **Will conduct thermal qualification performance test of strap**
- **Will vibrate straps with MVIC/FPA package assembly vibration**



K1100 Thermal Straps

- Consists of individual tubes, each containing 10,000 K1100 fibers
- End fittings designed to allow maximum, perpendicular heat flow into individual fibers

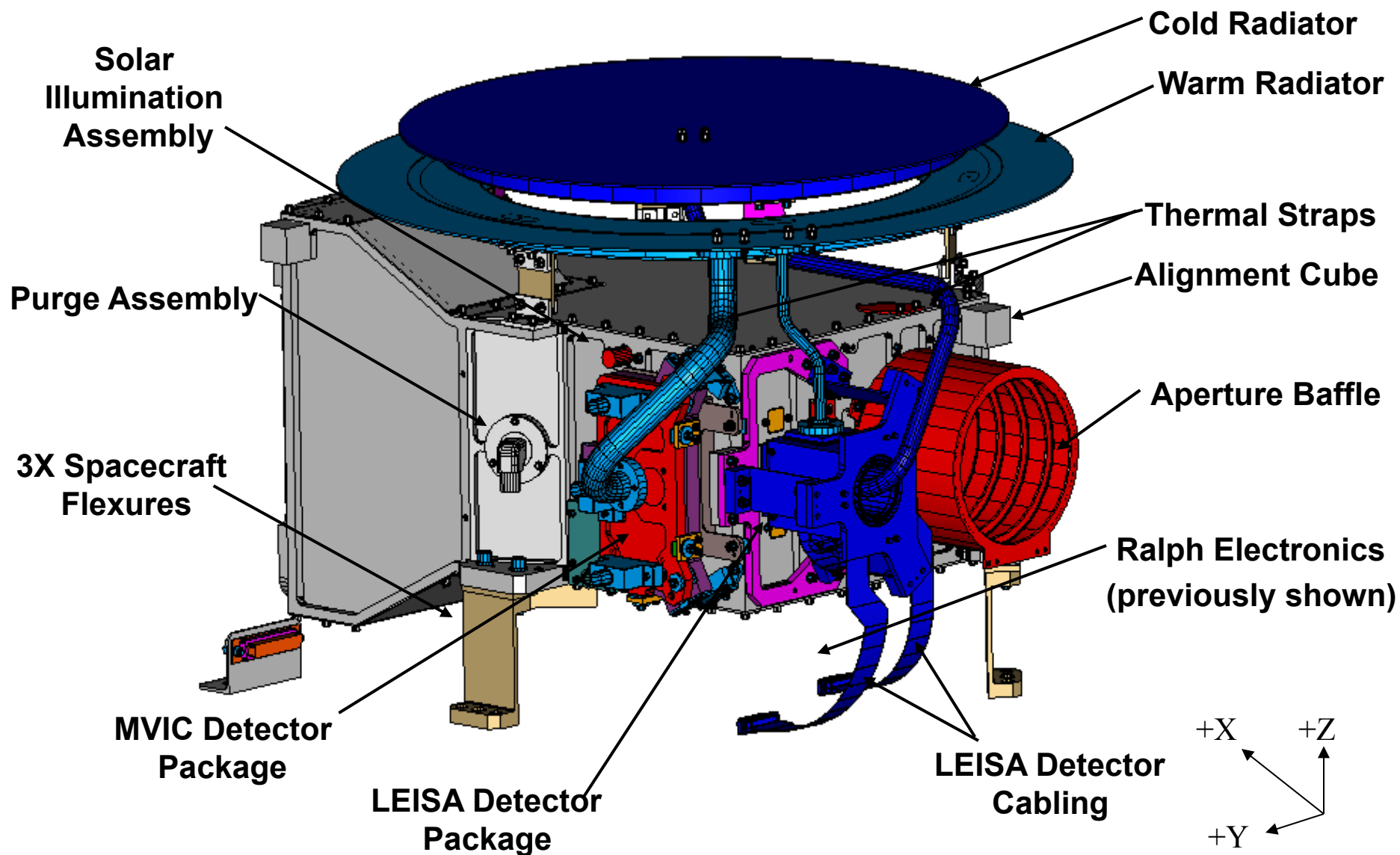
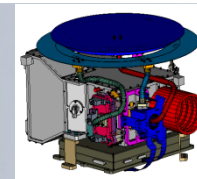


LEISA FP Thermal Strap





Telescope Detector Assembly (TDA)



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Ralph PER 10 Feb 2005